i.Core MX952

Built on the EDIMM 2.0 standard and powered by NXP® i.MX952, the i.Core MX952 delivers energy-efficient edge computing for AI-driven vision and sensor fusion. Featuring a 2.0 eTOPS eIQ® Neutron NPU, 3D graphics, real-time CPU processing, and integrated EdgeLock® functional safety, it is purpose-built for advanced industrial vision and HMI connectivity.

HIGHLIGHTS

- Standard EDIMM 2.0
- Powerful NXP ® i.MX952 processor with GPU, NPU and VPU
- Suitable for HMI and advanced multimedia applications

APPLICATIONS

Artificial Intelligence · Industrial · Digital Signage Infotainment · Transportation · Automotive · Avionics · Surveillance · Robotics · Biomedical/ Medical devices · Gaming · Home Automation

FEATURES

CPU	NXP® i.MX952
CORES	• 4x Arm Cortex-A55, up to 1.7 GHz • 1x Arm Cortex-M7, up to 800 MHz • 1x Arm Cortex-M33, up to 333 MHz
MEMORY	Up to 16GB (@ up to 6000 MT/s) LPDDR5
AI & GRAPHICS	- NXP eIQ® Neutron 2.0 eTOPS NPU - Arm Mali-G310 3D GPU supporting 50 GFLOPs FP32. • OpenGL® ES 3.2 • Vulkan® 1.3 • OpenCL 3.0 - 2D GPU
VIDEO INTERFACES	• 1x LVDS 4-lane • 1x LVDS/MIPI-DSI 4-lane • MIPI CSI 1x 4-lane or 2x 2-lane
VIDEO PROCESSING	• 4Kp60 H.265/H.264 decode, 1x JPEG Decoder • 4Kp30 H.264 encode, 1x JPEG Encoder
AUDIO	• SAI Interface
NETWORKING	2x Gb Ethernet interfaces (1x RGMII option available)
USB	2x USB 2.0
MASS STORAGE	eMMC drive soldered on-board
PERIPHERAL INTERFACES	UART, SPI, LPSPI, I²C, CAN Bus, JTAG, GPIOs
PCIE	1x PCIe Gen3 1-lane
OPERATING SYSTEM	• Linux Yocto • Android
POWER SUPPLY	+5V DC
DIMENSIONS	32 x 67,6 mm
OPERATING TEMPERATURE*	Extended Industrial qualified

* Valid for all components except CPU. Customer shall consider junction temperature for CPU. Temperature will widely depend on application. Specific cooling solutions could be necessary for the final system.

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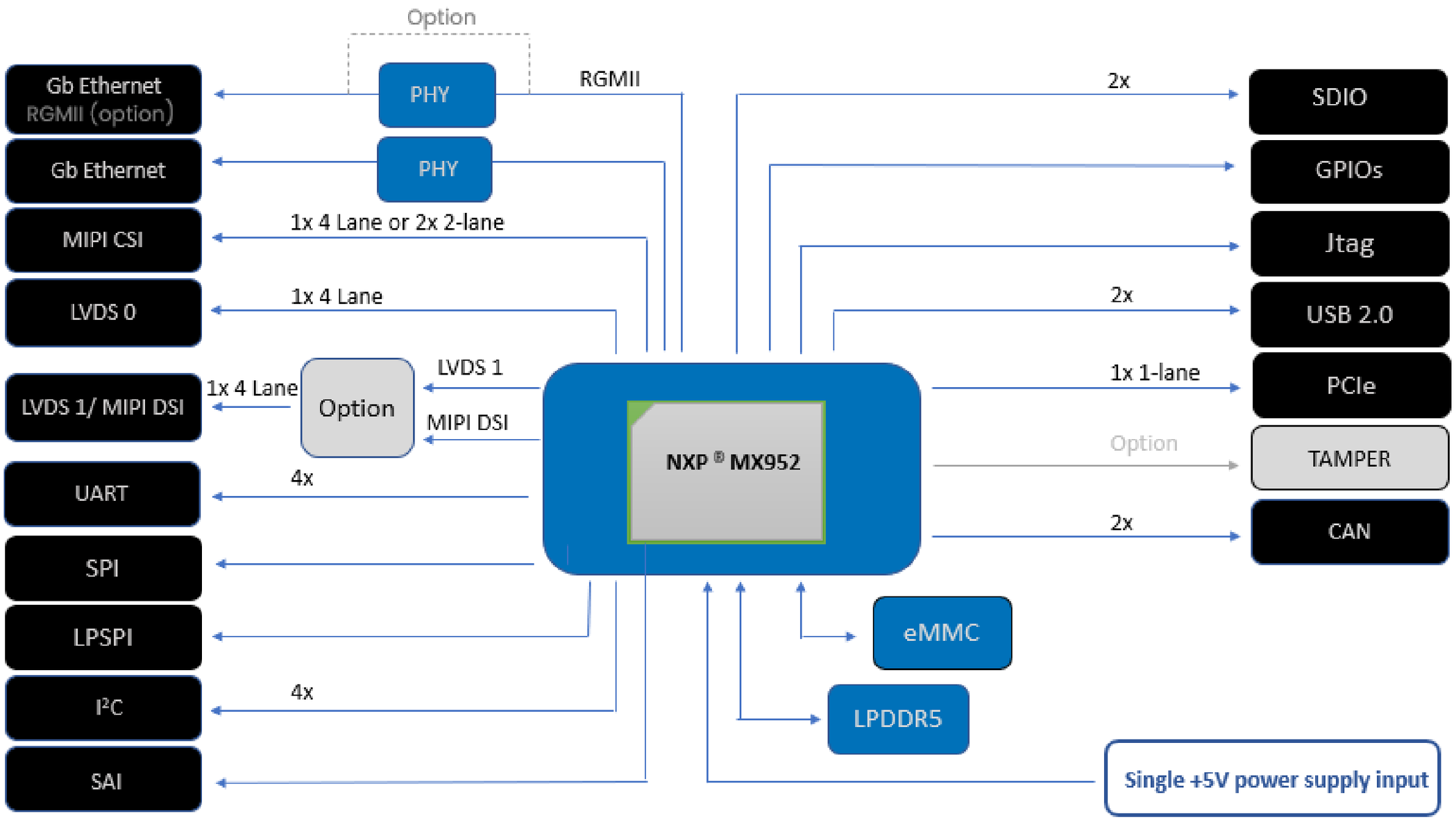
BLOCK DIAGRAM



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